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Details

Product Status	Active
Core Processor	508
Core Size	8-Bit
Speed	40MHz
Connectivity	I²C, SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	34
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LQFP
Supplier Device Package	44-LQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc9s08ac32cfger

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MC9S08AC60 Series Data Sheet

Covers MC9S08AC60 MC9S08AC48 MC9S08AC32

> MC9S08AC60 Series Rev. 3 8/2011





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Chapter 2 Pins and Connections



Figure 2-5. Basic System Connections



Chapter 6 Parallel Input/Output

6.6.9 Port E I/O Registers (PTED and PTEDD)

Port E parallel I/O function is controlled by the registers listed below.



Figure 6-22. Port E Data Register (PTED)

Table 6-21. PTED Register Field Descriptions

Field	Description
7:0 PTED[7:0]	Port E Data Register Bits — For port E pins that are inputs, reads return the logic level on the pin. For port E pins that are configured as outputs, reads return the last value written to this register. Writes are latched into all bits of this register. For port E pins that are configured as outputs, the logic level is driven out the corresponding MCU pin. Reset forces PTED to all 0s, but these 0s are not driven out the corresponding pins because reset also configures all port pins as high-impedance inputs with pullups disabled.

	7	6	5	4	3	2	1	0
R W	PTEDD7	PTEDD6	PTEDD5	PTEDD4	PTEDD3	PTEDD2	PTEDD1	PTEDD0
Reset	0	0	0	0	0	0	0	0

Figure 6-23. Data Direction for Port E (PTEDD)

Table 6-22. PTEDD Register Field Descriptions

Field	Description
7:0	Data Direction for Port E Bits — These read/write bits control the direction of port E pins and what is read for
PTEDD[7:0]	PTED reads.
	0 Input (output driver disabled) and reads return the pin value.
	1 Output driver enabled for port E bit n and PTED reads return the contents of PTEDn.



Source	Operation	Address Mode	Object Code	Cycles	Cyc-by-Cyc	Affect on CCR	
i onn					Details	V 1 1 H	INZC
BCC rel	Branch if Carry Bit Clear (if C = 0)	REL	24 rr	3	qqq	-11-	
BCLR n,opr8a	Clear Bit n in Memory (Mn ← 0)	DIR (b0) DIR (b1) DIR (b2) DIR (b3) DIR (b4) DIR (b5) DIR (b5) DIR (b7)	11 dd 13 dd 15 dd 17 dd 19 dd 1B dd 1D dd 1F dd	5 5 5 5 5 5 5 5 5 5	rfwpp rfwpp rfwpp rfwpp rfwpp rfwpp rfwpp rfwpp	- 1 1 -	
BCS rel	Branch if Carry Bit Set (if C = 1) (Same as BLO)	REL	25 rr	3	qqq	-11-	
BEQ rel	Branch if Equal (if Z = 1)	REL	27 rr	3	ppp	-11-	
BGE rel	Branch if Greater Than or Equal To (if $N \oplus V = 0$) (Signed)	REL	90 rr	3	qqq	-11-	
BGND	Enter active background if ENBDM=1 Waits for and processes BDM commands until GO, TRACE1, or TAGGO	INH	82	5+	fpppp	-11-	
BGT rel	Branch if Greater Than (if $Z (N \oplus V) = 0$) (Signed)	REL	92 rr	3	qqq	-11-	
BHCC rel	Branch if Half Carry Bit Clear (if $H = 0$)	REL	28 rr	3	ррр	-11-	
BHCS rel	Branch if Half Carry Bit Set (if $H = 1$)	REL	29 rr	3	ррр	-11-	
BHI <i>rel</i>	Branch if Higher (if $C \mid Z = 0$)	REL	22 rr	3	ppp	-11-	
BHS rel	Branch if Higher or Same (if C = 0) (Same as BCC)	REL	24 rr	3	qqq	-11-	
BIH <i>rel</i>	Branch if IRQ Pin High (if IRQ pin = 1)	REL	2F rr	3	ppp	-11-	
BIL <i>rel</i>	Branch if IRQ Pin Low (if IRQ pin = 0)	REL	2E rr	3	ppp	-11-	
BIT #opr8i BIT opr8a BIT opr16a BIT oprx16,X BIT oprx8,X BIT ,X BIT oprx16,SP BIT oprx8,SP	Bit Test (A) & (M) (CCR Updated but Operands Not Changed)	IMM DIR EXT IX2 IX1 IX SP2 SP1	A5 ii B5 dd C5 hh 11 D5 ee ff E5 ff F5 9E D5 ee ff 9E E5 ff	2 3 4 3 3 5 4	pp rpp prpp rpp rfp pprpp prpp	011-	- ↓ ↓ -
BLE rel	Branch if Less Than or Equal To (if Z I (N \oplus V) = 1) (Signed)	REL	93 rr	3	qqq	-11-	
BLO rel	Branch if Lower (if $C = 1$) (Same as BCS)	REL	25 rr	3	ppp	-11-	
BLS rel	Branch if Lower or Same (if $C \mid Z = 1$)	REL	23 rr	3	ppp	-11-	
BLT rel	Branch if Less Than (if $N \oplus V = 1$) (Signed)	REL	91 rr	3	ppp	-11-	
BMC rel	Branch if Interrupt Mask Clear (if I = 0)	REL	2C rr	3	ppp	-11-	
BMI <i>rel</i>	Branch if Minus (if N = 1)	REL	2B rr	3	ppp	-11-	
BMS rel	Branch if Interrupt Mask Set (if I = 1)	REL	2D rr	3	ppp	-11-	
BNE rel	Branch if Not Equal (if Z = 0)	REL	26 rr	3	ррр	-11-	



8.3.2.2 CRC Low Register (CRCL)



Figure 8-4. CRC High Register (CRCH)

Table 8-3. Register Field Descriptions

Field	Description
7:0 CRCL	CRCL This is the low byte of the 16-bit CRC register. Normally, a write to CRCL will cause the CRC generator to begin clocking through the 16-bit CRC generator. As a special case, if a write to CRCH has occurred previously, a subsequent write to CRCL will load the value in the register as the low byte of a 16-bit seed value directly into bits 7-0 of the shift register in the CRC generator. A read of CRCL will read bits 7-0 of the current CRC calculation result directly out of the shift register in the CRC generator.

8.4 Functional Description

To enable the CRC function, a write to the CRCH register will trigger the first half of the seed mechanism which will place the CRCH value directly into bits 15-8 of the CRC generator shift register. The CRC generator will then expect a write to CRCL to complete the seed mechanism.

As soon as the CRCL register is written to, its value will be loaded directly into bits 7-0 of the shift register, and the second half of the seed mechanism will be complete. This value in CRCH:CRCL will be the initial seed value in the CRC generator.

Now the first byte of the data on which the CRC calculation will be applied should be written to CRCL. This write after the completion of the seed mechanism will trigger the CRC module to begin the CRC checking process. The CRC generator will shift the bits in the CRCL register (MSB first) into the shift register of the generator. After all 8 bits have been shifted into the CRC generator (in the next bus cycle after the data write to CRCL), the result of the shifting, or the value currently in the shift register, can be read directly from CRCH:CRCL, and the next data byte to include in the CRC calculation can be written to the CRCL register.

This next byte will then also be shifted through the CRC generator's 16-bit shift register, and after the shifting has been completed, the result of this second calculation can be read directly from CRCH:CRCL.

After each byte has finished shifting, a new CRC result will appear in CRCH:CRCL, and an additional byte may be written to the CRCL register to be included within the CRC16-CCITT calculation. A new CRC result will appear in CRCH:CRCL each time 8-bits have been shifted into the shift register.

To start a new CRC calculation, write to CRCH, and the seed mechanism for a new CRC calculation will begin again.



Cyclic Redundancy Check (S08CRCV1)



are too fast, then the clock must be divided to the appropriate frequency. This divider is specified by the ADIV bits and can be divide-by 1, 2, 4, or 8.

9.5.2 Input Select and Pin Control

The pin control registers (APCTL3, APCTL2, and APCTL1) are used to disable the I/O port control of the pins used as analog inputs. When a pin control register bit is set, the following conditions are forced for the associated MCU pin:

- The output buffer is forced to its high impedance state.
- The input buffer is disabled. A read of the I/O port returns a zero for any pin with its input buffer disabled.
- The pullup is disabled.

9.5.3 Hardware Trigger

The ADC module has a selectable asynchronous hardware conversion trigger, ADHWT, that is enabled when the ADTRG bit is set. This source is not available on all MCUs. Consult the module introduction for information on the ADHWT source specific to this MCU.

When ADHWT source is available and hardware trigger is enabled (ADTRG=1), a conversion is initiated on the rising edge of ADHWT. If a conversion is in progress when a rising edge occurs, the rising edge is ignored. In continuous convert configuration, only the initial rising edge to launch continuous conversions is observed. The hardware trigger function operates in conjunction with any of the conversion modes and configurations.

9.5.4 Conversion Control

Conversions can be performed in either 10-bit mode or 8-bit mode as determined by the MODE bits. Conversions can be initiated by either a software or hardware trigger. In addition, the ADC module can be configured for low power operation, long sample time, continuous conversion, and automatic compare of the conversion result to a software determined compare value.

9.5.4.1 Initiating Conversions

A conversion is initiated:

- Following a write to ADCSC1 (with ADCH bits not all 1s) if software triggered operation is selected.
- Following a hardware trigger (ADHWT) event if hardware triggered operation is selected.
- Following the transfer of the result to the data registers when continuous conversion is enabled.

If continuous conversions are enabled a new conversion is automatically initiated after the completion of the current conversion. In software triggered operation, continuous conversions begin after ADCSC1 is written and continue until aborted. In hardware triggered operation, continuous conversions begin after a hardware trigger event and continue until aborted.



Internal Clock Generator (S08ICGV4)

10.4.10 Clock Mode Requirements

A clock mode is requested by writing to CLKS1:CLKS0 and the actual clock mode is indicated by CLKST1:CLKST0. Provided minimum conditions are met, the status shown in CLKST1:CLKST0 should be the same as the requested mode in CLKS1:CLKS0. Table 10-9 shows the relationship between CLKS, CLKST, and ICGOUT. It also shows the conditions for CLKS = CLKST or the reason CLKS \neq CLKST.

NOTE

If a crystal will be used before the next reset, then be sure to set REFS = 1 and CLKS = 1x on the first write to the ICGC1 register. Failure to do so will result in "locking" REFS = 0 which will prevent the oscillator amplifier from being enabled until the next reset occurs.

Actual Mode (CLKST)	Desired Mode (CLKS)	Range	Reference Frequency (f _{REFERENCE})	Comparison Cycle Time	ICGOUT	Conditions ¹ for CLKS = CLKST	Reason CLKS1 ≠ CLKST
Off (XX)	Off (XX)	х	0	_	0	_	
	FBE (10)	х	0	—	0	_	ERCS = 0
	SCM (00)	х	ficgirclk/7 ²	8/f _{ICGIRCLK}	ICGDCLK/R	Not switching from FBE to SCM	
SCM (00)	FEI (01)	0	f _{ICGIRCLK} /7 ⁽¹⁾	8/f _{ICGIRCLK}	ICGDCLK/R	_	DCOS = 0
	FBE (10)	х	f _{ICGIRCLK} /7 ⁽¹⁾	8/f _{ICGIRCLK}	ICGDCLK/R	_	ERCS = 0
	FEE (11)	х	f _{ICGIRCLK} /7 ⁽¹⁾	8/f _{ICGIRCLK}	ICGDCLK/R	_	DCOS = 0 or ERCS = 0
FEI	FEI (01)	0	f _{ICGIRCLK} /7	8/f _{ICGIRCLK}	ICGDCLK/R	DCOS = 1	
(01)	FEE (11)	х	f _{ICGIRCLK} /7	8/f _{ICGIRCLK}	ICGDCLK/R	_	ERCS = 0
FBE (10)	FBE (10)	х	0	_	ICGERCLK/R	ERCS = 1	
	FEE (11)	х	0	_	ICGERCLK/R	_	LOCS = 1 & ERCS = 1
FEE (11)	FEE	0	f _{ICGERCLK}	2/f _{ICGERCLK}	ICGDCLK/R ³	ERCS = 1 and DCOS = 1	_
	(11)	1	fICGERCLK	128/f _{ICGERCLK}	ICGDCLK/R ⁽²⁾	ERCS = 1 and DCOS = 1	_

Table 10-9. ICG State Table

¹ CLKST will not update immediately after a write to CLKS. Several bus cycles are required before CLKST updates to the new value.

² The reference frequency has no effect on ICGOUT in SCM, but the reference frequency is still used in making the comparisons that determine the DCOS bit

³ After initial LOCK; will be ICGDCLK/2R during initial locking process and while FLL is re-locking after the MFD bits are changed.



Internal Clock Generator (S08ICGV4)

ICGTRM =\$xx

Bit 7:0 TRIM

Only need to write when trimming internal oscillator; done in separate operation (see example #4)



Figure 10-16. ICG Initialization and Stop Recovery for Example #3

Chapter 12 Keyboard Interrupt (S08KBIV1)



- Pin contains software configurable pullup/pulldown device if IRQ is enabled (IRQPE = 1). Pulldown is enabled if rising edge detect is selected (IRQEDG = 1)
- 3. Pin contains integrated pullup device.
- 4. PTD3, PTD2, PTD7, and PTG4 contain both pullup and pulldown devices. Pulldown enabled when KBI is enabled (KBIPEn = 1) and rising edge is selected (KBEDGn = 1).
- 5. TPMCLK, TPM1CLK, and TPM2CLK options are configured via software; out of reset, TPM1CLK, TPM2CLK, and TPMCLK are available to TPM1, TPM2, and TPM3 respectively.

Figure 12-1. Block Diagram Highlighting KBI Module

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► PTG0/KBI1P0



12.2.2 KBI Pin Enable Register (KBIPE)



Figure 12-4. KBI Pin Enable Register (KBIPE)

Table 12-2	. KBIPE	Register	Field	Descriptions
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Field	Description
7:0 KBIPE[7:0]	 Keyboard Pin Enable for KBI Port Bits — Each of these read/write bits selects whether the associated KBI port pin is enabled as a keyboard interrupt input or functions as a general-purpose I/O pin. 0 Bit n of KBI port is a general-purpose I/O pin not associated with the KBI 1 Bit n of KBI port enabled as a keyboard interrupt input

12.3 Functional Description

12.3.1 Pin Enables

The KBIPEn control bits in the KBIPE register allow a user to enable (KBIPEn = 1) any combination of KBI-related port pins to be connected to the KBI module. Pins corresponding to 0s in KBIPE are general-purpose I/O pins that are not associated with the KBI module.

12.3.2 Edge and Level Sensitivity

Synchronous logic is used to detect edges. Prior to detecting an edge, enabled keyboard inputs in a KBI module must be at the deasserted logic level.

A falling edge is detected when an enabled keyboard input signal is seen as a logic 1 (the deasserted level) during one bus cycle and then a logic 0 (the asserted level) during the next cycle.

A rising edge is detected when the input signal is seen as a logic 0 during one bus cycle and then a logic 1 during the next cycle.

The KBIMOD control bit can be set to reconfigure the detection logic so that it detects edges and levels. In KBIMOD = 1 mode, the KBF status flag becomes set when an edge is detected (when one or more enabled pins change from the deasserted to the asserted level while all other enabled pins remain at their deasserted levels), but the flag is continuously set (and cannot be cleared) as long as any enabled keyboard input pin remains at the asserted level. When the MCU enters stop mode, the synchronous edge-detection logic is bypassed (because clocks are stopped). In stop mode, KBI inputs act as asynchronous level-sensitive inputs so they can wake the MCU from stop mode.



Serial Communications Interface (S08SCIV4)

13.1.3 Block Diagram

Figure 13-2 shows the transmitter portion of the SCI.



Figure 13-2. SCI Transmitter Block Diagram



Table 14-7. SPIS Register I	Field Descriptions
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Field	Description
7 SPRF	 SPI Read Buffer Full Flag — SPRF is set at the completion of an SPI transfer to indicate that received data may be read from the SPI data register (SPID). SPRF is cleared by reading SPRF while it is set, then reading the SPI data register. No data available in the receive data buffer Data available in the receive data buffer
5 SPTEF	 SPI Transmit Buffer Empty Flag — This bit is set when there is room in the transmit data buffer. It is cleared by reading SPIS with SPTEF set, followed by writing a data value to the transmit buffer at SPID. SPIS must be read with SPTEF = 1 before writing data to SPID or the SPID write will be ignored. SPTEF generates an SPTEF CPU interrupt request if the SPTIE bit in the SPIC1 is also set. SPTEF is automatically set when a data byte transfers from the transmit buffer into the transmit shift register. For an idle SPI (no data in the transmit buffer or the shift register and no transfer in progress), data written to SPID is transferred to the shifter almost immediately so SPTEF is set within two bus cycles allowing a second 8-bit data value to be queued into the transmit buffer. After completion of the transfer of the value in the shift register, the queued value from the transmit buffer will automatically move to the shifter and SPTEF will be set to indicate there is room for new data in the transmit buffer. O SPI transmit buffer not empty 1 SPI transmit buffer not empty
4 MODF	Master Mode Fault Flag — MODF is set if the SPI is configured as a master and the slave select input goes low, indicating some other SPI device is also configured as a master. The \overline{SS} pin acts as a mode fault error input only when MSTR = 1, MODFEN = 1, and SSOE = 0; otherwise, MODF will never be set. MODF is cleared by reading MODF while it is 1, then writing to SPI control register 1 (SPIC1). 0 No mode fault error 1 Mode fault error detected

14.4.5 SPI Data Register (SPID)

_	7	6	5	4	3	2	1	0
R W	Bit 7	6	5	4	3	2	1	Bit 0
Reset	0	0	0	0	0	0	0	0

Figure 14-9. SPI Data Register (SPID)

Reads of this register return the data read from the receive data buffer. Writes to this register write data to the transmit data buffer. When the SPI is configured as a master, writing data to the transmit data buffer initiates an SPI transfer.

Data should not be written to the transmit data buffer unless the SPI transmit buffer empty flag (SPTEF) is set, indicating there is room in the transmit buffer to queue a new transmit byte.

Data may be read from SPID any time after SPRF is set and before another transfer is finished. Failure to read the data out of the receive data buffer before a new transfer ends causes a receive overrun condition and the data from the new transfer is lost.



Timer/PWM Module (S08TPMV3)

When BDM is active, the coherency mechanism is frozen (unless reset by writing to TPMxSC register) such that the buffer latches remain in the state they were in when the BDM became active, even if one or both halves of the modulo register are written while BDM is active. Any write to the modulo registers bypasses the buffer latches and directly writes to the modulo register while BDM is active.



Reset the TPM counter before writing to the TPM modulo registers to avoid confusion about when the first counter overflow will occur.

15.5.4 TPM Channel n Status and Control Register (TPMxCnSC)

TPMxCnSC contains the channel-interrupt-status flag and control bits used to configure the interrupt enable, channel configuration, and pin function.



Figure 15-12. TPM Channel n Status and Control Register (TPMxCnSC)



Table 15-7.	. TPMxCnSC	Field Descri	iptions
-------------	------------	---------------------	---------

Field	Description
7 CHnF	Channel n flag. When channel n is an input-capture channel, this read/write bit is set when an active edge occurs on the channel n pin. When channel n is an output compare or edge-aligned/center-aligned PWM channel, CHnF is set when the value in the TPM counter registers matches the value in the TPM channel n value registers. When channel n is an edge-aligned/center-aligned PWM channel and the duty cycle is set to 0% or 100%, CHnF will not be set even when the value in the TPM counter registers matches the value in the TPM channel n value registers. A corresponding interrupt is requested when CHnF is set and interrupts are enabled (CHnIE = 1). Clear CHnF by reading TPMxCnSC while CHnF is set and then writing a logic 0 to CHnF. If another interrupt request occurs before the clearing sequence is complete, the sequence is reset so CHnF remains set after the clear sequence completed for the earlier CHnF. This is done so a CHnF interrupt request cannot be lost due to clearing a previous CHnF. Reset clears the CHnF bit. Writing a logic 1 to CHnF has no effect. 0 No input capture or output compare event occurred on channel n 1 Input capture or output compare event on channel n
6 CHnIE	 Channel n interrupt enable. This read/write bit enables interrupts from channel n. Reset clears CHnIE. O Channel n interrupt requests disabled (use for software polling) 1 Channel n interrupt requests enabled
5 MSnB	Mode select B for TPM channel n. When CPWMS=0, MSnB=1 configures TPM channel n for edge-aligned PWM mode. Refer to the summary of channel mode and setup controls in Table 15-8.
4 MSnA	 Mode select A for TPM channel n. When CPWMS=0 and MSnB=0, MSnA configures TPM channel n for input-capture mode or output compare mode. Refer to Table 15-8 for a summary of channel mode and setup controls. Note: If the associated port pin is not stable for at least two bus clock cycles before changing to input capture mode, it is possible to get an unexpected indication of an edge trigger.
3–2 ELSnB ELSnA	Edge/level select bits. Depending upon the operating mode for the timer channel as set by CPWMS:MSnB:MSnA and shown in Table 15-8, these bits select the polarity of the input edge that triggers an input capture event, select the level that will be driven in response to an output compare match, or select the polarity of the PWM output. Setting ELSnB:ELSnA to 0:0 configures the related timer pin as a general purpose I/O pin not related to any timer functions. This function is typically used to temporarily disable an input capture channel or to make the timer pin available as a general purpose I/O pin when the associated timer channel is set up as a software timer that does not require the use of a pin.

CPWMS	MSnB:MSnA	ELSnB:ELSnA	Mode	Configuration	
Х	xx	00	Pin is not controlled by TPM. It is reverted to general purpose I/O or other peripheral control		
0	00	01	Input capture	Capture on rising edge only	
		10		Capture on falling edge only	
		11		Capture on rising or falling edge	
	01	00	Output compare	Software compare only	
		01		Toggle output on channel match	
		10		Clear output on channel match	
		11		Set output on channel match	
	1X	10	Edge-aligned PWM	High-true pulses (clear output on channel match)	
		X1		Low-true pulses (set output on channel match)	

Table 15-8. Mode, Edge, and Level Selection



	Series Resistance	R1	0	Ω
Machine	Storage Capacitance	С	200	pF
	Number of Pulse per pin	_	3	
Lateb-up	Minimum input voltage limit		- 2.5	V
Laten-up	Maximum input voltage limit		7.5	V

Table A-4. ESD and Latch-up Test Conditions

Table A-5. ESD and Latch-Up	Protection Characteristics
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Num	С	Rating	Symbol	Min	Max	Unit
1	С	Human Body Model (HBM)	V _{HBM}	±2000	-	V
2	С	Machine Model (MM)	V _{MM}	±200	-	V
3	С	Charge Device Model (CDM)	V _{CDM}	± 500	-	V
4	С	Latch-up Current at T _A = 125°C	I _{LAT}	± 100	-	mA



Appendix A Electrical Characteristics and Timing Specifications







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A.12 FLASH Specifications

This section provides details about program/erase times and program-erase endurance for the FLASH memory.

Program and erase operations do not require any special power sources other than the normal V_{DD} supply. For more detailed information about program/erase operations, see Chapter 4, "Memory."

Num	С	Characteristic	Symbol	Min	Typ ¹	Max	Unit
1	Ρ	Supply voltage for program/erase	V _{prog/erase}	2.7		5.5	V
2	Р	Supply voltage for read operation	V _{Read}	2.7		5.5	V
3	Р	Internal FCLK frequency ²	f _{FCLK}	150		200	kHz
4	Р	Internal FCLK period (1/FCLK)	t _{Fcyc}	5		6.67	μS
5	Ρ	Byte program time (random location) ⁽²⁾	t _{prog}	9			t _{Fcyc}
6	С	Byte program time (burst mode) ⁽²⁾	t _{Burst}	4			t _{Fcyc}
7	Ρ	Page erase time ³	t _{Page}	4000			t _{Fcyc}
8	Р	Mass erase time ⁽²⁾	t _{Mass}	20,000			t _{Fcyc}
9	с	Program/erase endurance ⁴ T_L to $T_H = -40^{\circ}C$ to + 125°C $T = 25^{\circ}C$		10,000 —	 100,000	_	cyces
10	С	Data retention ⁵	t _{D_ret}	15	100	—	years

Table A-15. FLASH Characteristi	cs
---------------------------------	----

¹ Typical values are based on characterization data at V_{DD} = 5.0 V, 25°C unless otherwise stated.

² The frequency of this clock is controlled by a software setting.

³ These values are hardware state machine controlled. User code does not need to count cycles. This information supplied for calculating approximate time to program and erase.

- ⁴ Typical endurance for FLASH was evaluated for this product family on the 9S12Dx64. For additional information on how Freescale Semiconductor defines typical endurance, please refer to Engineering Bulletin EB619/D, *Typical Endurance for Nonvolatile Memory.*
- ⁵ Typical data retention values are based on intrinsic capability of the technology measured at high temperature and de-rated to 25°C using the Arrhenius equation. For additional information on how Freescale Semiconductor defines typical data retention, please refer to Engineering Bulletin EB618/D, *Typical Data Retention for Nonvolatile Memory.*